Contents

Part One

xiii Conference Committee
xvii Introduction

SESSION 1  DIP PEN NANOLITHOGRAPHY

8031 02  Tip-based nanofabrication: an approach to true nanotechnology (Keynote Paper) [8031-01]
K. P. Blochlock, A. R. Schofield, System Planning Corp. (United States); T. W. Kenny, Stanford Univ. (United States)

8031 03  Direct-write scanning probe lithography: towards a desktop lab (Invited Paper) [8031-02]

8031 04  Tip-based patterning of HOPG and CVD graphene (Invited Paper) [8031-03]
B. T. Hicks, N. Yoshimizu, Cornell Univ. (United States); C. O’Connell, Univ. of Rhode Island (United States); A. Lal, C. R. Pollock, Cornell Univ. (United States)

8031 05  Nanofabrication using heated probe tips (Invited Paper) [8031-04]
J. R. Felts, P. C. Fletcher, S. Somnath, J. Pikul, Univ. of Illinois at Urbana-Champaign (United States); Z. Dai, Advanced Diamond Technologies, Inc. (United States); W. K. Lee, P. E. Sheehan, U.S. Naval Research Lab. (United States); W. P. King, Univ. of Illinois at Urbana-Champaign (United States)

8031 06  Laser-assisted nanoprocessing and growth of semiconductor nanostructures (Invited Paper) [8031-05]
D. J. Hwang, S.-G. Ryu, E. Kim, J.-H. Yoo, Univ. of California, Berkeley (United States); B. Xiang, O. Dubon, A. M. Minor, Univ. of California, Berkeley (United States) and Lawrence Berkeley National Lab. (United States); C. P. Grigoropoulos, Univ. of California, Berkeley (United States)

SESSION 2  ADVANCED NANOSCALE MATERIALS SYSTEMS

8031 07  Semiconductor nanomembranes: a platform for new science and technology (Keynote Paper) [8031-06]
M. G. Lagally, A. M. Kiefer, D. M. Paskiewicz, F. Cavallo, S. A. Scott, Z. Q. Ma, D. E. Savage, Univ. of Wisconsin-Madison (United States)

8031 09  Si pillar structured thermal neutron detectors: fabrication challenges and performance expectations (Invited Paper) [8031-08]
R. J. Nikolic, Q. Shao, L. F. Yoss, A. M. Conway, R. Radev, T. F. Wang, Lawrence Livermore National Lab. (United States); M. Dar, N. Dee, C. L. Cheung, Univ. of Nebraska-Lincoln (United States); L. Fabris, C. L. Britton, M. N. Ericson, Oak Ridge National Lab. (United States)
SESSION 3  MICRO/NANOTECHNOLOGY FOR MM-WAVE/THZ SECURITY APPLICATIONS

8031 0A  The role of THz and submillimeter wave technology in DHS (Keynote Paper) [8031-09]
T. Coty, U.S. Dept. of Homeland Security (United States); A. Fuller-Tedeschi, Strategic Analysis, Inc. (United States)

8031 0B  High-performance heterostructure backward diode detectors (Invited Paper) [8031-10]
P. Fay, Z. Zhang, Univ. of Notre Dame (United States)

8031 0C  A micro-fabricated sheet-beam Orotron THz source (Invited Paper) [8031-11]

8031 0D  MEMS-based uncooled THz detectors for staring imagers (Invited Paper) [8031-12]
J. A. Cox, R. Higashl, F. Nusselbeh, C. Zins, Honeywell ACS Sensor & Wireless Lab. (United States)

8031 0E  Integrated chip-scale THz technology (Invited Paper) [8031-13]
M. C. Wanke, Sandia National Labs. (United States); M. Lee, Sandia National Labs. (United States) and The Univ. of Texas at Dallas (United States); C. D. Nordquist, M. J. Cich, M. Cavaliere, A. M. Rowen, J. R. Gillen, C. L. Arlington, Sandia National Labs. (United States); A. D. Grine, LMATA Govt. Services (United States); C. T. Fuller, J. L. Reno, Sandia National Labs. (United States)

SESSION 4  THZ CHARACTERIZATION OF SEMICONDUCTOR MATERIALS

8031 0F  Programmatic perspectives with technical examples for THz materials characterization (Keynote Paper) [8031-14]
W. Buchwald, Air Force Research Lab. (United States)

8031 0G  THz characterization of hydrated and anhydrous materials (Invited Paper) [8031-15]
A. Sokolnikov, Visual Solutions & Applications (United States)

8031 0H  2DEG GaN hot electron microbolometers and quantum cascade lasers for THz heterodyne sensing (Invited Paper) [8031-16]
R. Ramaswamy, K. Wang, A. Stier, Univ. at Buffalo, SUNY (United States); A. Muraviev, Univ. at Buffalo, SUNY (United States) and Rensselaer Polytechnic Institute (United States); G. Strasser, A. Markelz, Univ. at Buffalo, SUNY (United States); M. Shur, Rensselaer Polytechnic Institute (United States); R. Gaska, Sensor Electronic Technology, Inc. (United States); A. Sergeev, V. Mitin, Univ. at Buffalo, SUNY (United States)

8031 0J  Silicon and nitride FETs for THz sensing (Invited Paper) [8031-18]
M. Shur, Rensselaer Polytechnic Institute (United States)

8031 0K  Terahertz QC-lasers and active metamaterial antennas (Invited Paper) [8031-19]
B. S. Williams, P. Hon, A. Tavallaee, T. Itoh, Univ. of California, Los Angeles (United States); Q. Chen, Northrop Grumman Aerospace Systems (United States)
SESSION 5 MEMS OPTICAL SYSTEMS

8031 0M MEMs adaptive optics at the Naval Research Laboratory (Invited Paper) [8031-21]
S. R. Restaino, J. R. Andrews, T. Martinez, C. C. Wilcox, F. Santiago, U.S. Naval Research Lab. [United States]; D. M. Payne, Narrascape (United States)

8031 0N Actuation for deformable thin-shelled composite mirrors (Invited Paper) [8031-22]
C. C. Wilcox, U.S. Naval Research Lab. (United States); D. V. Wick, G. Soehnel, B. E. Bagwell, Sandia National Labs. (United States); R. C. Romeo, R. N. Martin, Composite Mirror Applications, Inc. (United States); M. S. Baker, N. L. Breivik, B. L. Boyce, Sandia National Labs. (United States); T. Martinez, S. R. Restaino, U.S. Naval Research Lab. (United States)

8031 0O Micro ion frequency standard (Invited Paper) [8031-23]

8031 0P Imaging a linearly or circularly polarized scene: micro-components and shrimp (Invited Paper) [8031-24]

SESSION 6 NANOPHOTONICS

8031 OR Optical components for lab-in-a-tube systems (Invited Paper) [8031-26]
E. J. Smith, Institute for Solid State and Materials Research (Germany); Y. Mei, Institute for Solid State and Materials Research (Germany) and Fudan Univ. (China); O. G. Schmidt, Institute for Solid State and Materials Research (Germany)

8031 OS Integrated microsystems for molecular pathology (Invited Paper) [8031-27]
A. Scherer, G. Maltezos, I. Malik, E. Kartalov, California Institute of Technology (United States)

SESSION 7 PHOTON TRAPPING WITH 1D STRUCTURES AND NOVEL DEVICE APPLICATIONS

8031 OT Efficient light-trapping nanostructures in thin silicon solar cells (Invited Paper) [8031-28]
S. E. Han, Massachusetts Institute of Technology (United States); A. Mavrokefalos, Massachusetts Institute of Technology (United States) and The Cypress Institute (Cyprus); M. S. Branham, G. Chen, Massachusetts Institute of Technology (United States)

8031 OU Magnetically responsive photonic nanostructures: making color using magnets (Invited Paper) [8031-29]
L. He, Y. Yin, Univ. of California, Riverside (United States)

SESSION 8 ADVANCED NANOMATERIALS, NANOLITHOGRAPHY AND NANOMANUFACTURING

8031 OV Functionalized DNA materials for sensing and medical applications (Keynote Paper) [8031-30]
D. L. Woolard, U.S. Army Research Office (United States); J. O. Jensen, U.S. Army Edgewood Chemical Biological Ctr. (United States)
8031 OX  Manufacturing self-assembled coatings of micro- and nano-particles by controlled evaporation of drops and thin films (Invited Paper) [8031-32]
J. Xiao, Columbia Univ. (United States); R. Bhardwaj, The John Hopkins Univ. (United States); D. Attinger, Columbia Univ. (United States)

8031 OY  Graphene optoelectronics based on antidot superlattices (Invited Paper) [8031-33]
S. Strauf, E.-H. Yang, Stevens Institute of Technology (United States)

SESSION 9  MAST-NAVIGATION: JOINT SESSION WITH CONFERENCE 8045

8031 OZ  Distributed autonomous mapping of indoor environments (Invited Paper) [8031-34]
J. Rogers, M. Paluri, A. Cunningham, H. I. Christensen, Georgia Institute of Technology (United States); N. Michael, V. Kumar, Univ. of Pennsylvania (United States); J. Ma, L. Matthies, Jet Propulsion Lab. (United States)

8031 10  Autonomous navigation with teams of aerial robots (Invited Paper) [8031-35]
N. Michael, V. Kumar, Univ. of Pennsylvania (United States)

8031 11  Autonomous landing and ingress of micro-air-vehicles in urban environments based on monocular vision (Invited Paper) [8031-36]
R. Brockers, Jet Propulsion Lab. (United States); P. Bouffard, Univ. of California, Berkeley (United States); J. Ma, L. Matthies, Jet Propulsion Lab. (United States); C. Tomlin, Univ. of California, Berkeley (United States)

8031 12  Velocity estimation using optic flow and radar (Invited Paper) [8031-37]
S. A. Gerardi, J. S. Humbert, Univ. of Maryland, College Park (United States); L. E. Pierce, K. Sarabandi, Univ. of Michigan (United States)

8031 13  Compact beam scanning 240GHz radar for navigation and collision avoidance (Invited Paper) [8031-38]
K. Sarabandi, M. Vahidpour, M. Moallem, J. East, Univ. of Michigan (United States)

SESSION 10  MAST-COMMUNICATION: JOINT SESSION WITH CONFERENCE 8045

8031 14  New techniques for efficient flexible wireless transceivers in nanometer CMOS (Invited Paper) [8031-39]
M. P. Flynn, D. T. Lin, M. Ghahramani, L. Li, Univ. of Michigan (United States)

8031 15  Reconfigurable firmware-defined radios synthesized from standard digital logic cells (Invited Paper) [8031-40]
M. Faisal, Y. Park, D. D. Wentzloff, Univ. of Michigan (United States)

8031 16  Radio signal strength tracking and control for robotic networks (Invited Paper) [8031-41]
P. L. Yu, J. N. Twigg, B. M. Sadler, U.S. Army Research Lab. (United States)

8031 17  Enhanced ad hoc wireless connectivity in complex environment using small radio repeater systems (Invited Paper) [8031-42]
K. Sarabandi, Y. J. Song, J. Oh, Univ. of Michigan (United States)
SESSION 11  QUALITY FACTORS FOR NANO/MICROMECHANICAL RESONATORS

8031 18 Precision navigation and timing enabled by microtechnology: Are we there yet? [8031-43]
A. M. Shkel, Defense Advanced Research Projects Agency (United States)

8031 19 Energy dissipation in micromechanical resonators (Invited Paper) [8031-44]
F. Ayazi, L. Sorenson, R. Tabrizian, Georgia Institute of Technology (United States)

8031 1A Effect of surface chemistry on the quality factors of micromechanical resonators (Invited Paper) [8031-45]
J. A. Henry, Y. Wang, M. A. Hines, Cornell Univ. (United States)

8031 1B Finite element modelling and simulation of thermo-elastical damping of MEMS vibrations (Invited Paper) [8031-46]
S. Kausinis, Kaunas Univ. of Technology (Lithuania); K. Yee, Jet Propulsion Lab. (United States); R. Barauskas, Kaunas Univ. of Technology (Lithuania)

8031 1C Thermal energy loss mechanisms in micro- to nano-scale devices (Invited Paper) [8031-47]
A. E. Duwel, J. Lozow, C. J. Fisher, T. Phillips, The Charles Stark Draper Lab. (United States); R. H. Olson, Sandia National Labs. (United States); M. Weinberg, The Charles Stark Draper Lab. (United States)

SESSION 12  MEMS PERFORMANCE CHALLENGES

8031 1E An analysis of microsystems development at Sandia National Laboratories (Keynote Paper) [8031-49]
G. V. Herrera, D. R. Myers, Sandia National Labs. (United States)

8031 1F MEMS performance challenges: packaging and shock tests (Invited Paper) [8031-50]
J. Chang, C. Yang, B. Zhang, L. Lin, Univ. of California, Berkeley (United States)

8031 1G Sensors for hydraulic-induced fracturing characterization (Invited Paper) [8031-51]
J. Mireles, Jr., Univ. Autónoma de Ciudad Juárez (Mexico); H. Estrada, Ctr. Nacional de Metrologia (Mexico); R. C. Ambrosio, Univ. Autónoma de Ciudad Juárez (Mexico)

8031 1H Tribological challenges in MEMS and their mitigation via vapor phase lubrication (Invited Paper) [8031-52]
M. T. Dugger, Sandia National Labs. (United States)

8031 1I MEMS and nanostructures: challenges and opportunities. The case of the fight against tuberculosis (Invited Paper) [8031-53]
L. M. Lopez-Marín, Y. D. Contreras-Valeriano, C. Arenas, Univ. Nacional Autónoma de México (Mexico); H. V. Estrada, Ctr. Nacional de Metrologia (Mexico); V. M. Castaño, Univ. Nacional Autónoma de México (Mexico)